

## APPLICATION DATA SHEET

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***Application Information:***

<b>Title of Invention:</b>	HIGH FREQUENCY HEATING APPARATUS AND ITS CONTROL METHOD
<b>Application Type:</b>	regular, utility

**Attorney Docket Number:** 38893

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**Suggested Figure for Publication -**

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***Representative Information:***

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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

***Domestic Priority Information:***

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***Foreign Priority Information:***

Doc.No:2003-121876; Country - JP; Date: 2003-04-25 us-priority-claimed

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Doc.No:2003-131804; Country - JP; Date: 2003-05-09 us-priority-claimed

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